AUTOMOTIVE GRADE

PD - 96318

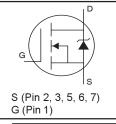
International TOR Rectifier

AUIRF3805S-7P AUIRF3805L-7P

HEXFET® Power MOSFET

Features

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

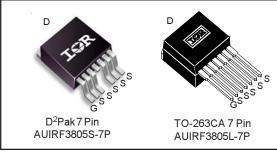


V _{(BR)DSS}	3	55V
R _{DS(on)}	typ.	2.0m $Ω$
	max.	2.6m Ω⑦
I _D		240A

S Source

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G D Gate Drain

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only: and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	240	
$I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	170	^
$T_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	160	Α
I _{DM}	Pulsed Drain Current ①	1000	
$P_{D} @ T_{C} = 25^{\circ}C$	Maximum Power Dissipation	300	W
	Linear Derating Factor	2.0	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ®	440	m l
E _{AS} (tested)	Single Pulse Avalanche Energy Tested Value 2	680	mJ
I _{AR}	Avalanche Current ①	See Fig.12a,12b,15,16	Α
E _{AR}	Repetitive Avalanche Energy ①		mJ
dv/dt	Peak Diode Recovery dv/dt ③	2.3	V/ns
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
H ₀ JC	Junction-to-Case ®		0.50	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient		62	1C/VV
$H_{\theta JA}$	Junction-to-Ambient (PCB Mount, steady state) ©		40	

HEXFET® is a registered trademark of International Rectifier.

*Qualification standards can be found at http://www.irf.com/ www.irf.com

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.05		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)} SMD	Static Drain-to-Source On-Resistance		2.0	2.6	mΩ	V _{GS} = 10V, I _D = 140A ③
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	110			S	$V_{DS} = 25V, I_D = 140A$
I _{DSS}	Drain-to-Source Leakage Current			20		$V_{DS} = 55V, V_{GS} = 0V$
				250	μA	$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200		V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-200	nA	$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		130	200		I _D = 140A
Q_{gs}	Gate-to-Source Charge		53		nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		49		1	V _{GS} = 10V ③
t _{d(on)}	Turn-On Delay Time		23			$V_{DD} = 28V$
t _r	Rise Time		130		1	I _D = 140A
t _{d(off)}	Turn-Off Delay Time		80		ns	$R_G = 2.4\Omega$
t _f	Fall Time		52		1	V _{GS} = 10V ③
L_D	Internal Drain Inductance		4.5			Between lead,
			4.5		nH	6mm (0.25in.)
L _S	Internal Source Inductance		7.5		n n	from package G
			7.5			and center of die contact
C _{iss}	Input Capacitance		7820			$V_{GS} = 0V$
C _{oss}	Output Capacitance		1260			$V_{DS} = 25V$
C_{rss}	Reverse Transfer Capacitance		610		1	f = 1.0MHz, See Fig. 5
Coss	Output Capacitance		4310		pF	$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		980		1	$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance @		1540		1	$V_{GS} = 0V$, $V_{DS} = 0V$ to 44V

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			240		MOSFET symbol
	(Body Diode)			240		showing the
I _{SM}	Pulsed Source Current		1	1000		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	٧	$T_J = 25$ °C, $I_S = 140A$, $V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		45	68	ns	$T_J = 25$ °C, $I_F = 140$ A, $V_{DD} = 28$ V
Q _{rr}	Reverse Recovery Charge		35	53	nC	di/dt = 100A/µs ③
t _{on}	Forward Turn-On Time	Intrinsio	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

Notes:

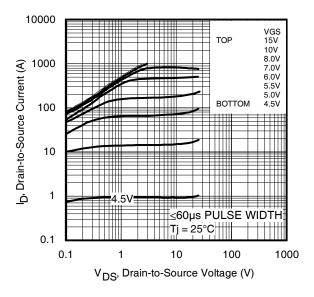
- Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② This value determined from sample failure population starting $T_J = 25^{\circ}C$, L=0.043mH, $R_G = 25\Omega$, $I_{AS} = 140A$, $V_{GS} = 10V$.
- $\ \ \,$ $\ \ \,$ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
- ⑤ This is applied to D²Pak, when mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.
- ⑥ R_θ is measured at T_J of approximately 90°C.
- Solder mounted on IMS substrate.
- ® Limited by T_J max starting T_J = 25°C, L=0.043mH, R_G = 25 Ω , I_{AS} = 140A, V_{GS} =10V.Part not recommended for use above this value.

Qualification Information[†]

Qualification Level		Automotive (per AEC-Q101) ††				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensi	tivity Level	7L-D2 PAK MSL1 , 260°C				
	Manakina Mankal	Class M4(+/-425V)				
	Machine Model	(per AEC-Q101-002)				
500		Class H3A(+/-4000V)				
ESD	Human Body Model	(per AEC-Q101-001)				
	0	Class C5 (+/-1000V)				
	Charged Device Model	(per AEC-Q101-005)				
RoHS Complian	nt	Yes				

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.



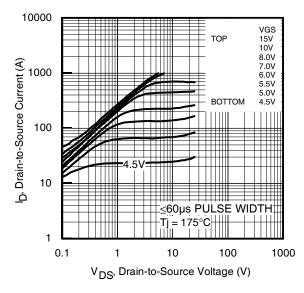
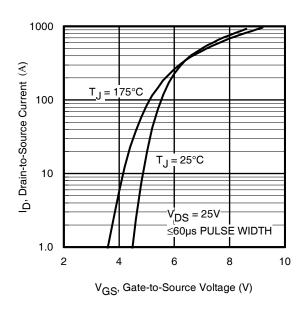


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



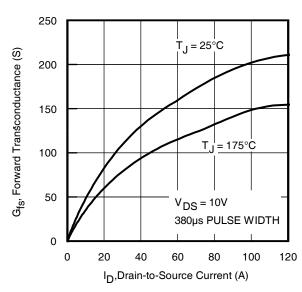
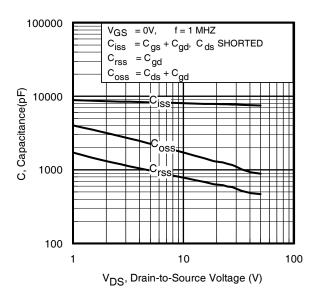


Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance vs. Drain Current



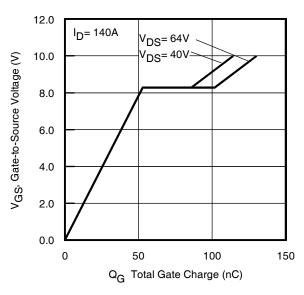
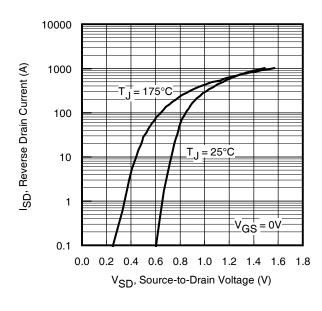


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage





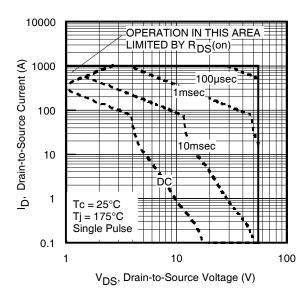
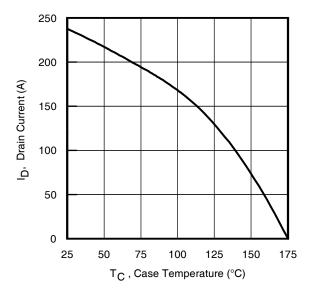


Fig 8. Maximum Safe Operating Area



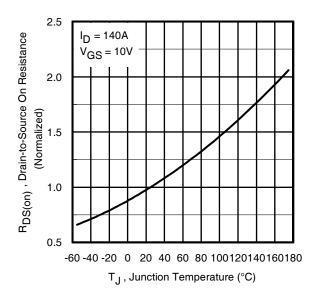


Fig 9. Maximum Drain Current vs. Case Temperature

Fig 10. Normalized On-Resistance vs. Temperature

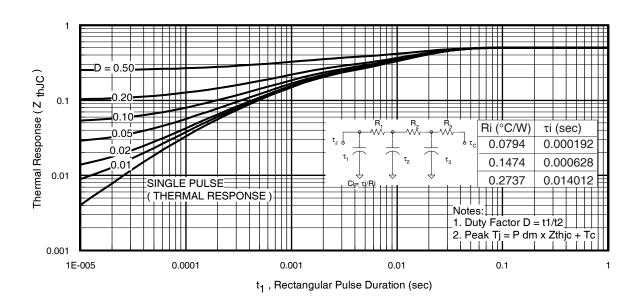


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

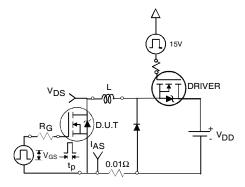


Fig 12a. Unclamped Inductive Test Circuit

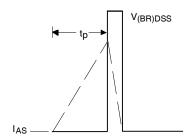


Fig 12b. Unclamped Inductive Waveforms

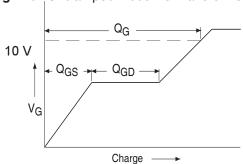


Fig 13a. Basic Gate Charge Waveform

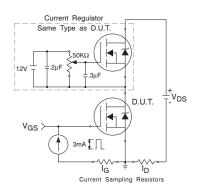


Fig 13b. Gate Charge Test Circuit www.irf.com

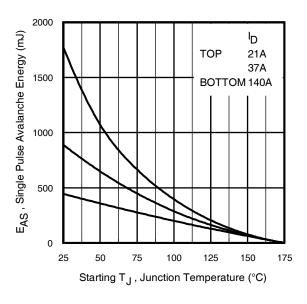


Fig 12c. Maximum Avalanche Energy vs. Drain Current

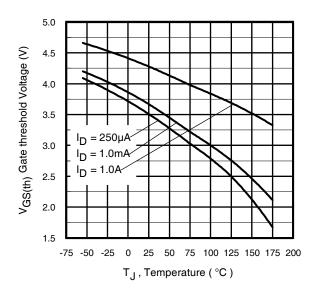


Fig 14. Threshold Voltage vs. Temperature

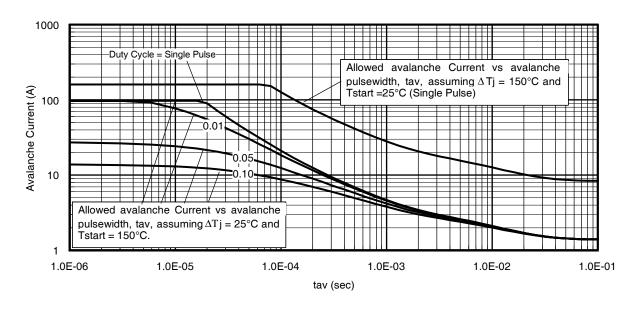


Fig 15. Typical Avalanche Current vs. Pulsewidth

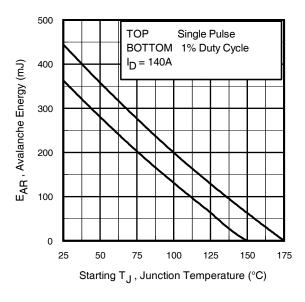


Fig 16. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption: Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long as Timax is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{imax} (assumed as 25°C in Figure 15, 16). t_{av} = Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

 $P_{D\;(ave)}$ = 1/2 ($1.3 \cdot BV \cdot I_{av})$ = $\Delta T/\; Z_{thJC}$ $I_{av} = 2\Delta T / [1.3 \cdot BV \cdot Z_{th}]$ E_{AS (AR)} = P_{D (ave)}-t_{av}

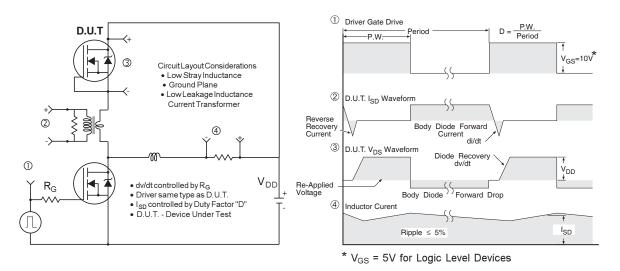


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

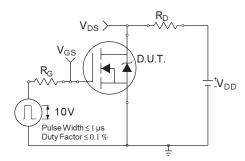


Fig 18a. Switching Time Test Circuit

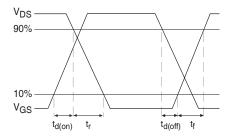
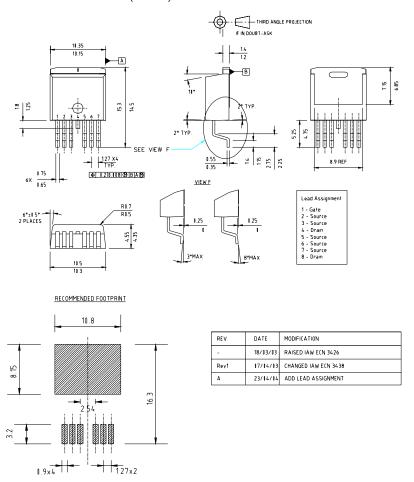


Fig 18b. Switching Time Waveforms

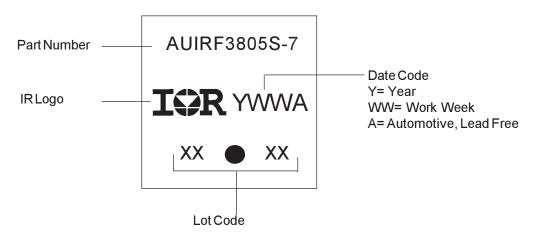
International TOR Rectifier

D²Pak - 7 Pin Package Outline

Dimensions are shown in millimeters (inches)



D²Pak - 7 Pin Part Marking Information

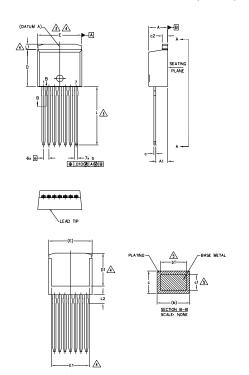


Note: For the most current drawing please refer to IR website at http://www.irf.com/package/
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www.irf.com

AUIRF3805S/L-7P

TO-263CA 7 Pin Long Leads Package Outline

Dimensions are shown in millimeters (inches)



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3\Dimension D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- 5. DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
- 6. CONTROLLING DIMENSION: INCH.
- 7,- OUTLINE CONFORM TO JEDEC TO-263 CA

S						
	DIMENSIONS				Й	
M B O	MILLIM	ETERS	RS INCHES		O T E S	
Ĺ	MIN.	MAX.	MIN.	MAX.	S	
Α	4.06	4.83	.160	.190		
A1	2.03	3.02	.080	.119		
b	0.51	0.91	.020	.036		
ь1	0.51	0.81	.020	.032	5	
С	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1,14	1.65	.045	.065		
D	8.51	9.65	.335	.380	3	
D1	6.86	-	.270	-	4	
E	9.65	10,67	.380	.420	3,4	
E1	6.22	-	.245		4	
e	1.27	BSC	.050 BSC			
L	13,46	14,10	.530	.555		
L1	-	1.65	-	.065	4	
L2	_	6,35	-	.250		

LEAD ASSIGNMENTS

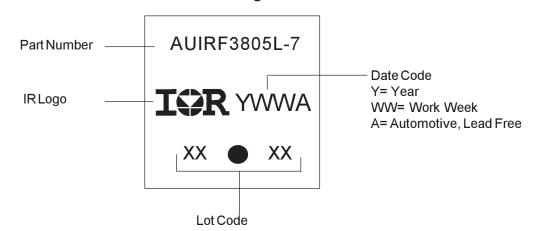
<u>HEXFET</u>

- 1.- GATE 2.- SOURCE

- 2.- SOURCE 3.- SOURCE 4.- DRAIN 5.- SOURCE 6.- SOURCE 7.- SOURCE

11

TO-263CA - 7 Pin Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/ www.irf.com

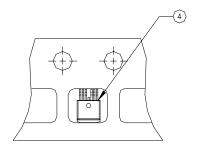
D²Pak - 7 Pin Tape and Reel

NOTES, TAPE & REEL, LABELLING:

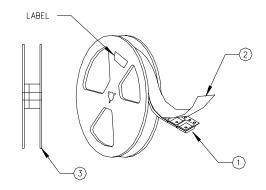
- 1. TAPE AND REEL.
 - 1,1 REEL SIZE 13 INCH DIAMETER.
 - 1.2 EACH REEL CONTAINING 800 DEVICES.
 - 1.3 THERE SHALL BE A MINIMUM OF 42 SEALED POCKETS CONTAINED IN THE LEADER AND A MINIMUM OF 15 SEALED POCKETS IN THE TRAILER.
 - 1.4 PEEL STRENGTH MUST CONFORM TO THE SPEC. NO. 71-9667
 - 1.5 PART ORIENTATION SHALL BE AS SHOWN BELOW.
 - 1.6 REEL MAY CONTAIN A MAXIMUM OF TWO UNIQUE LOT CODE/DATE CODE COMBINATIONS.

 REWORKED REELS MAY CONTAIN A MAXIMUM OF THREE UNIQUE LOT CODE/DATE CODE COMBINATIONS.

 HOWEVER, THE LOT CODES AND DATE CODES WITH THEIR RESPECTIVE QUANTITIES SHALL APPEAR ON THE BAR CODE LABEL FOR THE AFFECTED REEL.



- 2. LABELLING (REEL AND SHIPPING BAG).
 - 2.1 CUST. PART NUMBER (BAR CODE): IRFXXXXSTRL-7P
 - 2.2 CUST. PART NUMBER (TEXT CODE): IRFXXXXSTRL-7P
 - 2.3 I.R. PART NUMBER: IRFXXXXSTRL-7P
 - 2.4 QUANTITY:
 - 2.5 VENDOR CODE: IR
 - 2.6 LOT CODE:
 - 2.7 DATE CODE:



Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF3805L-7P	TO-262	Tube	50	AUIRF3805L-7P
AUIRF3805S-7P	D2Pak	Tube	50	AUIRF3805S-7P
		Tape and Reel Left	800	AUIRF3805S-7PTRL
		Tape and Reel Right	800	AUIRF3805S-7PTRR

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IR warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with IR's standard warranty. Testing and other quality control techniques are used to the extent IR deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

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